



# N-Channel 40-V (D-S) MOSFET

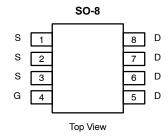
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$r_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)		
40	0.009 @ V <sub>GS</sub> = 10 V	14		
	0.012 @ V <sub>GS</sub> = 4.5 V	12		

#### **FEATURES**

- TrenchFET® Power MOSFET
- 100% R<sub>g</sub> Tested

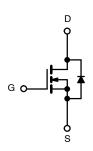


Available



Ordering Information:

Si4840DY Si4840DY-T1 (with Tape and Reel) Si4840DY-E3 (Lead (Pb)-Free) Si4840DY-T1-E3 (Lead (Pb)-Free with Tape and Reel)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	40		V	
Gate-Source Voltage		V <sub>GS</sub>	±20			
0 II	T <sub>A</sub> = 25°C	- I <sub>D</sub>	14	10		
Continuous Drain Current (T <sub>J</sub> = 150°C) <sup>a</sup>	T <sub>A</sub> = 70°C		11	8		
Pulsed Drain Current		I <sub>DM</sub>	50		Α	
Avalanche Current	1 04 11	I <sub>AS</sub>	30 45			
Avalanche Energy (Single Pulse)	L = 0.1 mH	E <sub>AS</sub>			mJ	
Continuous Source Current (Diode Conduction) <sup>a</sup>	<b>'</b>	I <sub>S</sub>	2.8	1.4	Α	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25°C	5	3.1	1.56	144	
	T <sub>A</sub> = 70°C	P <sub>D</sub>	2.0	1.0	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150		°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
	t ≤ 10 sec	R <sub>thJA</sub>	33	40			
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		65	80	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State		17	21			

Notes a. Surface Mounted on 1" x 1" FR4 Board.

## Vishay Siliconix



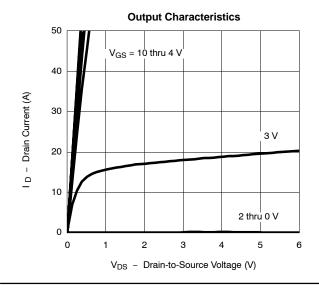
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Static	1			1	ı	•
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0		3.0	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$		1		
		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			5	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 14 A		0.0075	0.009	Ω
Diam-Source Off-State Resistance-		$V_{GS} = 4.5 \text{ V}, I_D = 12 \text{ A}$		0.0095	0.012	52
Forward Transconductancea	9fs	$V_{DS} = 15 \text{ V}, I_{D} = 14 \text{ A}$		50		S
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = 2.8 A, V <sub>GS</sub> = 0 V		0.75	1.1	V
Dynamic <sup>b</sup>						
Total Gate Charge	Qg			18.5	28	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 20 V, $V_{GS}$ = 5 V, $I_D$ = 14 A		6		
Gate-Drain Charge	$Q_{gd}$			7.5		
Gate Resistance	R <sub>g</sub>		0.2	0.8	1.2	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			15	30	
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_1 = 20 \Omega$		10	20	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$\begin{aligned} &V_{DD} = 20 \text{ V, } R_L = 20 \Omega\\ &I_D \cong 1 \text{ A, } V_{GEN} = 10 \text{ V, } R_G = 6 \Omega \end{aligned}$		50	100	
Fall Time	t <sub>f</sub>			20	40	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 2.8 A, di/dt = 100 A/μs		30	60	1

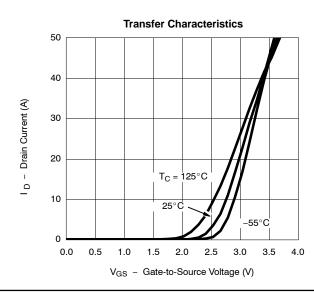
#### Notes

- Pulse test; pulse width  $\leq 300 \, \mu s$ , duty cycle  $\leq 2\%$ . Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



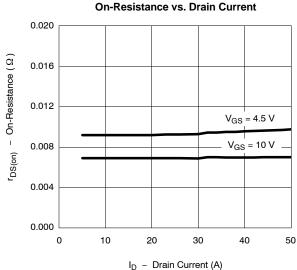




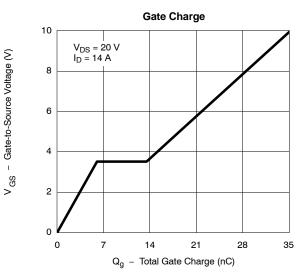




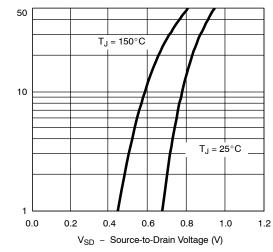
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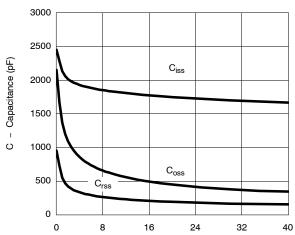




Source-Drain Diode Forward Voltage

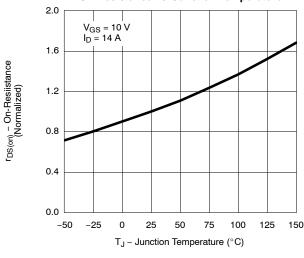


Capacitance

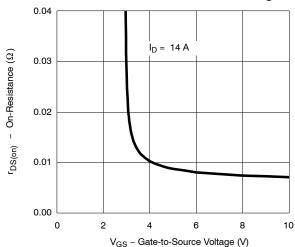


V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

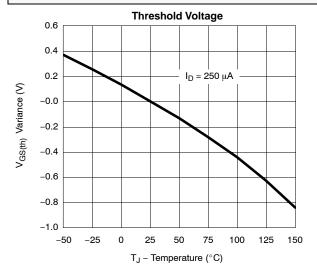


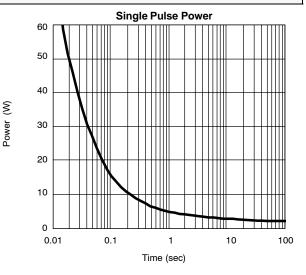
Source Current (A)

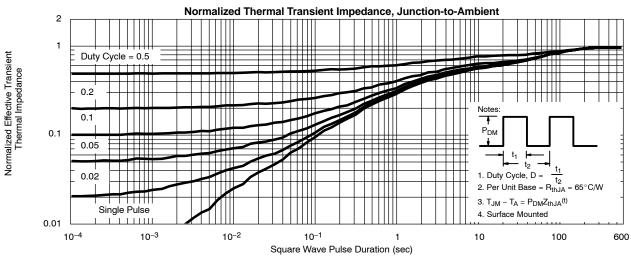
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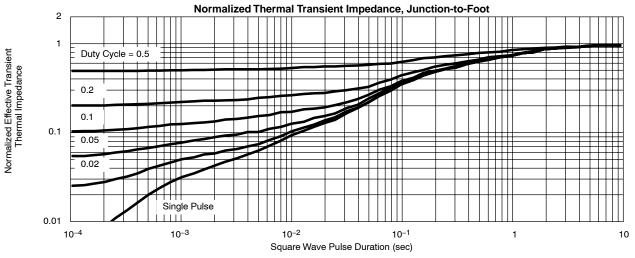


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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?71188">http://www.vishay.com/ppg?71188</a>.



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